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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/834,939	04/16/2001	Wen Lo Shieh		5444	
759	0 12/21/2001				
Wen Lo SHIEI	H		EXAM	EXAMINER	
PO Box 82-144 TAIPEI,			NORRIS, JEREMY C		
TAIWAN	$\Lambda\Pi$		ART UNIT	PAPER NUMBER	
	/ <u>#</u> \]]		3841		

DATE MAILED: 12/21/2001

Please find below and/or attached an Office communication concerning this application or proceeding.

				S			
		Application N	o. A	cant(s)			
•		09/834,939	SHIE	H, WEN LO			
Office Action Summary		Examiner	Art U	nit			
		Jeremy Norris	2841				
	- The MAILING DATE of this commun	nication appears on the co	ver sheet with the corresp	oondence address			
Pariod for	r Renly						
THE N - Extension after S - If the I - If NO - Failur	ORTENED STATUTORY PERIOD F MAILING DATE OF THIS COMMUN sions of time may be available under the provision SIX (6) MONTHS from the mailing date of this com period for reply specified above is less than thirty (period for reply is specified above, the maximum s e to reply within the set or extended period for repl sply received by the Office later than three months d patent term adjustment. See 37 CFR 1.704(b).	IICATION. s of 37 CFR 1.136(a). In no event, the imunication. 30) days, a reply within the statutory statutory period will apply and will expense.	owever, may a reply be timely filed minimum of thirty (30) days will be pire SIX (6) MONTHS from the mail	considered timely. ing date of this communication. I.S.C. § 133).			
1)	Responsive to communication(s)	filed on					
2a)□	This action is FINAL.	2b) This action is no	n-final.	1. 11 t			
3)□	The second transfer of the second transfer of the second for formal matters, prosecution as to the merits is						
	on of Claims						
4)⊠	Claim(s) $1-4$ is/are pending in the	application.					
	4a) Of the above claim(s) is	/are withdrawn from cons	deration.				
5)□	Claim(s) is/are allowed.						
6)⊠	6)⊠ Claim(s) <u>1-4</u> is/are rejected.						
7)	7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/or election requirement.							
l .	ion Papers						
0,	The specification is objected to by	the Examiner.					
10)🖂	The drawing(s) filed on <u>16 April 20</u>	<u>01</u> is/are: a) accepted o	b)⊠ objected to by the E	xaminer.			
1	Applicant may not request that any	objection to the drawing(s) b	e held in abeyance. See 3	/ CFR 1.05(a).			
11)	The proposed drawing correction f	ïled on is: a)∐ apı	orovea b) i alsapprovea	Dy the Examiner.			
If approved, corrected drawings are required in reply to this Office action.							
1	The oath or declaration is objected	to by the Examiner.					
Priority	under 35 U.S.C. §§ 119 and 120		051100 0440(5) (4	or (f)			
	Acknowledgment is made of a cla		er 35 U.S.C. § 119(a)-(d	<i>)</i> (1 <i>).</i>			
a	ı)⊠ All b)□ Some * c)□ None c	of:					
	1. Certified copies of the prior	rity documents have beer	received.	Mo			
	2. Certified copies of the prior	rity documents have beer	received in Application	nu			
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.							
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
1	a) The translation of the foreign Acknowledgment is made of a cla	n language provisional ap	olication has been receiv	ed.			
Attachm							
1) 🛛 No	otice of References Cited (PTO-892) otice of Draftsperson's Patent Drawing Revie formation Disclosure Statement(s) (PTO-144	ew (PTO-948) 49) Paper No(s)	4) Interview Summary (P 5) Notice of Informal Pate 6) Other:	TO-413) Paper No(s) · ent Application (PTO-152)			

Art Unit: 2841

DETAILED ACTION

Priority

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Drawings

The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the limitation "wherein polymeric film die carrier (or substrate) or PI die carrier (or substrate) and the die are soldered at one end of a wire, the other end is mounted with a metal pad within the leg position which is recessed on the polymeric die film carrier (or substrate) or PI die carrier (or substrate) must be shown or the feature(s) canceled from the claim(s). No new matter should be entered.

A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

Claim Objections

Claim 1 is objected to because of the following informalities:

Claim 1 is not a single sentence and thus contains a period in the middle of the claim which is not a portion of an abbreviation (see MPEP 608.01(m)). Appropriate correction is required.

Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

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The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 1-4 are rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to enable one skilled in the art to which it pertains, or with which it is most nearly connected, to make and/or use the invention. The limitation "wherein polymeric film die carrier (or substrate) or PI die carrier (or substrate) and the die are soldered at one end of a wire, the other end is mounted with a metal pad within the leg position which is recessed on the polymeric die film carrier (or substrate) or PI die carrier (or substrate)" is a direct contradiction. It is well known in the art that dice are either wire bonded or flip chip mounted, not both. Since Applicant has no disclosure teaching a method using both techniques concurrently, the specification does not enable one of ordinary skill in the art to make the invention.

Claims 1-4 rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention (see above description).

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

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Claims 1-4 rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

The claims contain structural limitations enclosed within parentheses. It is unclear as to whether these structural delineations are being positively claimed or not. Furthermore, it is unclear what is meant by "changed by a packing material". Examiner assumes this to mean sealed with a packing material.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1 and 3 are rejected under 35 U.S.C. 102(b) as being anticipated by Hiruta et al (US 5,461,197).

Hiruta et al (hereafter Hiruta) disclose, referring to figure 5A, an ultra-thin film package, characterized in that polymeric film die carrier (50) is employed, and the leg position for die bonding is made into a recess shape to lower the thickness after bonding, and polymeric film die carrier is made into a thin film shape by a fabrication technique, and the I/O leg position is made into a recess shape and the die (53) is glued to the polymeric film die carrier and then sealed with a package material (57), wherein polymeric film die carrier and the die is mounted with a metal pad within the leg position which is recessed on the polymeric die film carrier, and the electrode (51) of the metal

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pad is protruded from the back face of the polymeric film die carrier [claim 1], wherein the electrical bonding of the die with polymeric film die carrier is a die bonding method such that the I/O bump of the die and the metal pad on the leg position of the polymeric film die carrier are bonded [claim 3].

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 2 and 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hiruta.

Hiruta discloses the claimed invention as best understood my the Examiner, as described above except for the limitation that a metal plate is provided at the polymeric film die carrier, corresponding to the back face of the die position. However, it would have been obvious, to one having ordinary skill in the art, at the time of invention, to provide such a heat sink as is well known in the art. The motivation for doing so would have been to draw heat away from the chip and thus create a more reliable device.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

US 5,690,270

Gore.

US 6,084,781

Klein.

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US 6,094,354

Nakajoh et al.,

US 6,281,448

Tsukamoto.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jeremy Norris whose telephone number is 703-306-5737. The examiner can normally be reached on Mon.-Th., 9AM - 6:30 PM and alt. Fri. 9AM-5:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jeffrey Gaffin can be reached on 703-308-3301. The fax phone numbers for the organization where this application or proceeding is assigned are 703-305-7724 for regular communications and 703-305-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

JCSN

December 17, 2001

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